



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: Kwon, Heung-Kyu; Cho, Min-Kyo  
Assignee: Samsung Electronics Co., Limited  
Title: Semiconductor Chip Package and Method of Fabricating the Same  
Serial No.: 09/464,322 Filing Date: December 15, 1999  
Examiner: Chris C. Chu Group Art Unit: 2815  
Docket No.: AB-881 US

#184400/C  
AUG 27 2002  
San Francisco, California  
August 27, 2002

COMMISSIONER FOR PATENTS  
Washington, D. C. 20231

RESPONSE TO OFFICE ACTION

Dear Sir:

This paper is responsive to the Office Action that was mailed from the U.S. Patent and Trademark Office on February 28, 2002, which has a period of time for reply that ended May 28, 2002. The time for responding has been extended to August 28, 2002 by the enclosed Petition and extension of time fee.

Applicant respectfully requests reconsideration of the Application in view of the following amendments and remarks.

AMENDMENTS

IN THE CLAIMS

This submission cancels Claims 1 and 16 and amends Claims 2, 3, 5-8, 10, 11, 13, 14, 17-20. The following is a clean version of the Claims. In accordance with 37 C.F.R. § 1.121(c)(1)(ii), Attachment A provides a marked up version of amended Claims 2-8, 10, 11,